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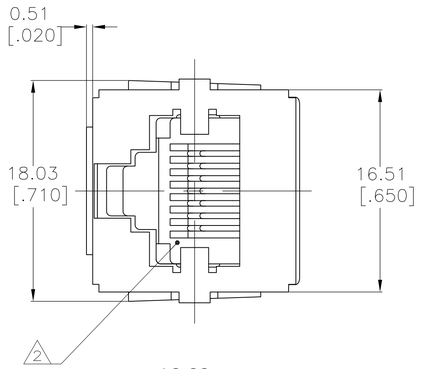
LOC	DIST
AA	00

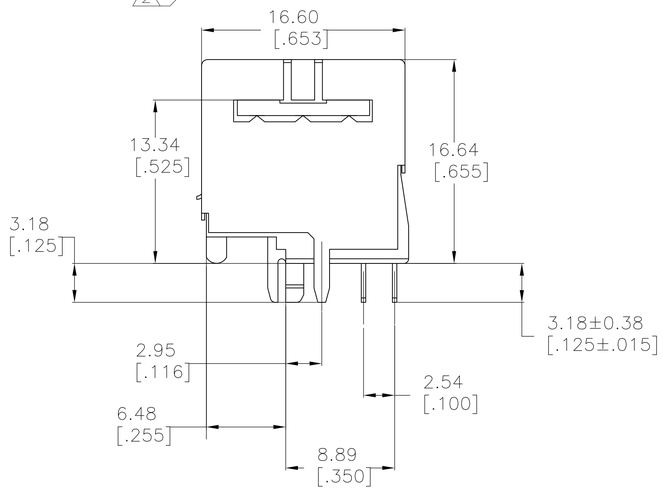
REVISIONS

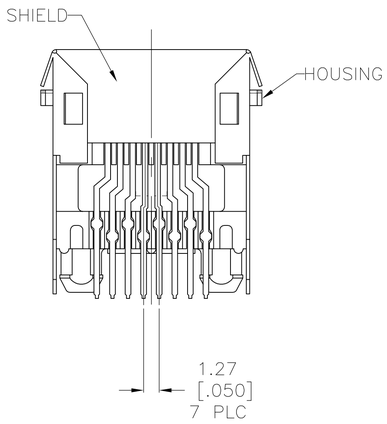
P	LTR	DESCRIPTION	DATE	DWN	APVD
	D1	REVISED PER ECO-11-004835	11MAR11	RK	HMR

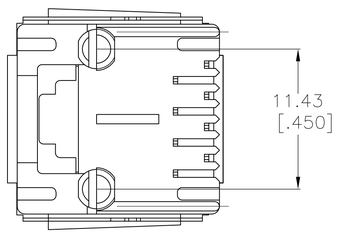
1. MATERIAL:
HOUSING – POLYESTER MOLDING COMPOUND, COLOR: BLACK
TERMINALS – 0.35[.0138] THICK PHOS BRONZE PLATED WITH 1.27µm[.000050] MIN THICK GOLD IN LOCALIZED AREA AND 3.81µm[.000150] MIN THICK MATTE TIN IN SOLDER AREA OVER 1.27µm[.000050] MIN THICK NICKEL UNDERPLATE
SHIELD – COPPER ZINC ALLOY PLATED WITH 3.0µm [.000120] MIN THICK REFLOWED TIN.

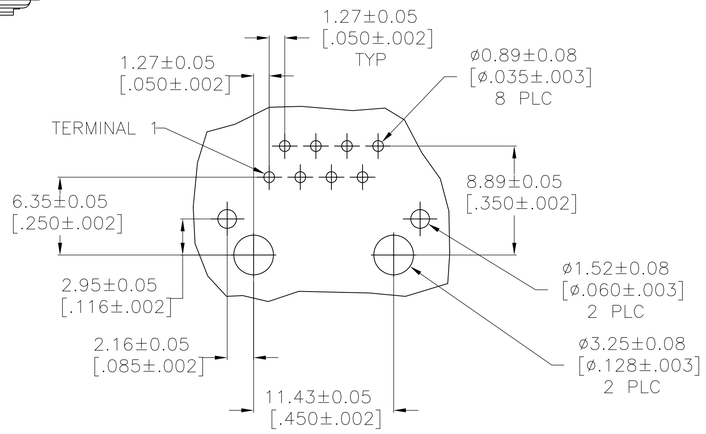
△2 CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68 AND REA BULLETIN 345-81, PE-76 SPECIFICATION FOR MODULAR TELEPHONE HARDWARE.



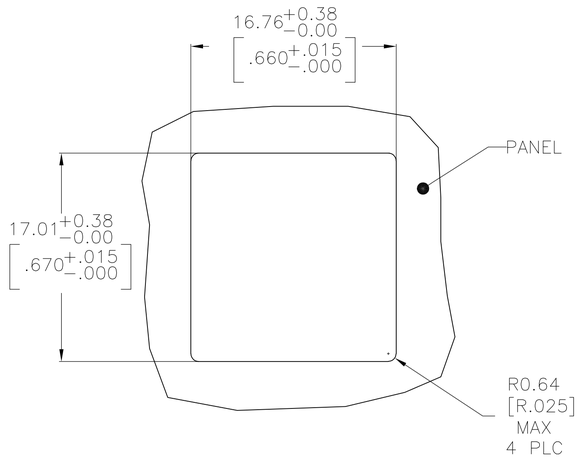








RECOMMENDED PRINTED CIRCUIT BOARD LAYOUT
COMPONENT SIDE SHOWN



RECOMMENDED PANEL CUTOUT

5406436-1
PART NO.

THIS DRAWING IS A CONTROLLED DOCUMENT.

DIMENSIONS: mm [INCHES]

TOLERANCES UNLESS OTHERWISE SPECIFIED:
0 PLC ± –
1 PLC ± –
2 PLC ± 0.13[.005]
3 PLC ± –
4 PLC ± –
ANGLES ± –

MATERIAL: SEE NOTE 1
FINISH: SEE NOTE 1

DWN 09JUN2005 J. ALCORTA – DOCK5
CHK 09JUN2005 J. WESTMAN
APVD 09JUN2005 S. FLICKINGER
PRODUCT SPEC 108-1163
APPLICATION SPEC 114-2048
WEIGHT –
CUSTOMER DRAWING

TE Connectivity

NAME: MODULAR JACK ASSEMBY, TOP ENTRY, 8 POSITION, SHIELDED, WITH PANEL STOPS PRINTED CIRCUIT BOARD AND PANEL GROUNDS

SIZE	CAGE CODE	DRAWING NO	RESTRICTED TO
A1	00779	C-5406436	–

SCALE 4:1 SHEET 1 OF 1 REV D1

4805 (3/11)